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PART NO. SEE TABLE

REVISIONS

LTR	DESCRIPTION	Drawing	DATE
A	RELEASE NEW PRODUCT	GARY	05/23/07
B	加標錫腳長度尺寸	GARY	06/09/07

CUSTOMER DRAWING

RECOMMENDED PCB LAYOUT

NOTE:

1.MATERIAL :

BASE : HIGH TEMPERATURE THERMOPLASTIC UL94V-0,
 TERMINAL:COPPER ALLOY,THICKNESS = 0.30 mm
 FORKLICK:COPPER ALLOY,THICKNESS = 0.30 mm

2,PLATING:

CONTACT:GOLD OVER 50u" MIN NICKEL UNDERPLATE
 SOLDER TAIL:150u"MIN MISTY TIN 50u" MIN NICKEL
 UNDERPLATE
 GOLD SPECIFICATION:SEE TABLE

3.ELECTRONICAL SPECIFICATION:

CURRENT RATING: 1.5 AMPERE PER CONTACT
 CONTACT RESISTANCE: 30 MILLIOHMS MAX.
 INSULATION RESISTANCE: 1000 MEGOHMS MIN.
 DIELECTRIC WITHSTANDING VOLTAGE: 500 VDC.
 OPERATING TEMPERATURE: -40°C~+85°C

4.MEETS THE REQUIREMENTS OF DIRECTIVE 2002/95/EC
 OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL OF 27
 JANUARY 2003 ON THE RESTRICTION OF THE USE OF CERTAIN
 HAZARDOUS SUBSTANCES IN ELECTRICAL AND ELECTRONIC
 EQUIPMENT(ROHS)

TABLE

007-01-00422	15 u" GOLD	LCP BLACK
007-01-00423	15 u" GOLD	PA9T BLACK
PART NO.	PLATED	PLASTIC&COLOR

DIMENSION ARE MILLIMETERS TOLERANCES ARE : DECIMALS .X i0 0.30 .XX i0 0.25 ANGLE: X ± 3'	APPROVALS		DATE	PART NO.
	DRAWN	GARY	06/09/07	007-01-00422/00423
CHECKED			TITLE:	
APPROVALS			SATA22PIN新下彈點DIP 特殊PIN錯位型,無凸點	
	SIZE	SCALE :	DRAWING NO.	REV.
	mm	1 : 1	000488	B
	ID NO.	XXXXXXXXXX	SHEET 1 OF 1	

DESCRIPTION

NO

QTY

UNIT

DO NOT SCALE DRAWING

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